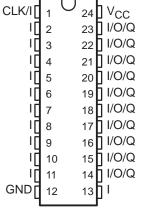
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- Second-Generation PLD Architecture
- High-Performance Operation:
 (External Foodback)

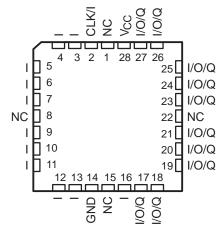
f_{max} (External Feedback) . . . 71 MHz Propagation Delay . . . 10 ns Max

- Increased Logic Power Up to 22 Inputs and 10 Outputs
- Increased Product Terms Average of 12 Per Output
- Variable Product Term Distribution Allows More Complex Functions to Be Implemented
- Each Output Is User Programmable for Registered or Combinational Operation, Polarity, and Output Enable Control
- Power-Up Clear on Registered Outputs
- TTL-Level Preload for Improved Testability
- Extra Terms Provide Logical Synchronous Set and Asynchronous Reset Capability
- Fast Programming, High Programming Yield, and Unsurpassed Reliability Ensured Using Ti-W Fuses
- AC and DC Testing Done at the Factory Utilizing Special Designed-In Test Features
- Dependable Texas Instruments Quality and Reliability
- Package Options Include Plastic
 Dual-In-Line and Chip Carrier Packages

NT PACKAGE (TOP VIEW)



FN PACKAGE (TOP VIEW)



NC — No internal connection
Pin assignments in operating mode

description

The TIBPAL22V10-10C is a programmable array logic device featuring high speed and functional equivalency when compared to presently available devices. They are implemented with the familiar sum-of-products (AND-OR) logic structure featuring the new concept "Programmable Output Logic Macrocell". These IMPACT-X™ circuits combine the latest Advanced Low-Power Schottky technology with proven titanium-tungsten fuses to provide reliable, high-performance substitutes for conventional TTL logic.

These devices contain up to 22 inputs and 10 outputs. They incorporate the unique capability of defining and programming the architecture of each output on an individual basis. Outputs may be registered or nonregistered and inverting or noninverting as shown in the output logic macrocell diagram. The ten potential outputs are enabled through the use of individual product terms.

Further advantages can be seen in the introduction of variable product term distribution. This technique allocates from 8 to 16 logical product terms to each output for an average of 12 product terms per output. This variable allocation of terms allows far more complex functions to be implemented than in previously available devices.

This device is covered by U.S. Patent 4,410,987. IMPACT-X is a trademark of Texas Instruments Incorporated.



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description (continued)

Circuit design is enhanced by the addition of a synchronous set and an asynchronous reset product term. These functions are common to all registers. When the synchronous set product term is a logic 1, the output registers are loaded with a logic 1 on the next low-to-high clock transition. When the asynchronous reset product term is a logic 1, the output registers are loaded with a logic 0. The output logic level after set or reset depends on the polarity selected during programming. Output registers can be preloaded to any desired state during testing. Preloading permits full logical verification during product testing.

With features such as programmable output logic macrocells and variable product term distribution, the TIBPAL22V10-10C offers quick design and development of custom LSI functions with complexities of 500 to 800 equivalent gates. Since each of the ten output pins may be individually configured as inputs on either a temporary or permanent basis, functions requiring up to 21 inputs and a single output or down to 12 inputs and 10 outputs are possible.

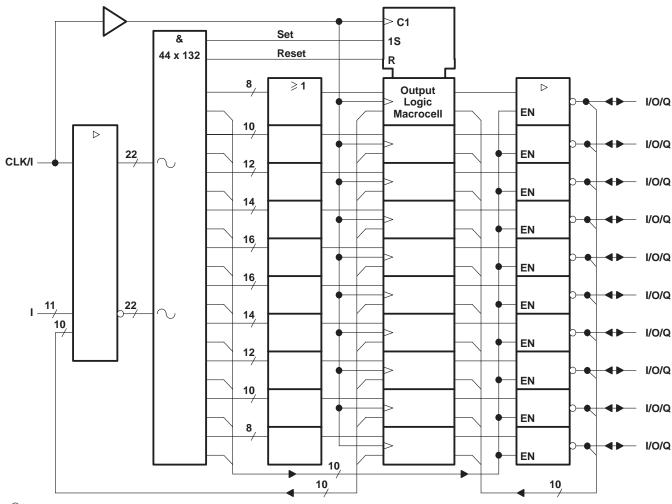
A power-up clear function is supplied that forces all registered outputs to a predetermined state after power is applied to the device. Registered outputs selected as active-low power up with their outputs high. Registered outputs selected as active-high power up with their outputs low.

A single security fuse is provided on each device to discourage unauthorized copying of fuse patterns. Once blown, the verification circuitry is disabled and all other fuses will appear to be open.

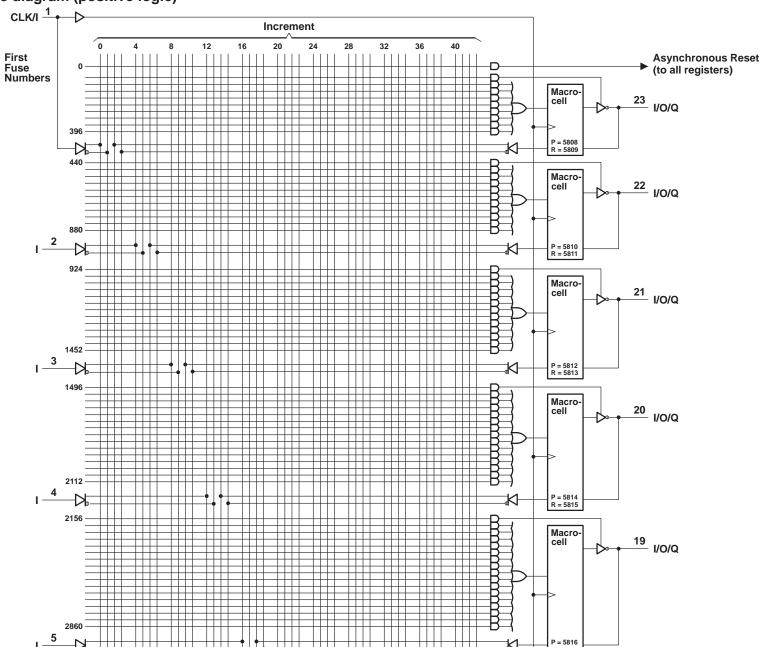
The TIBPAL22V10-10C is characterized for operation from 0°C to 75°C.



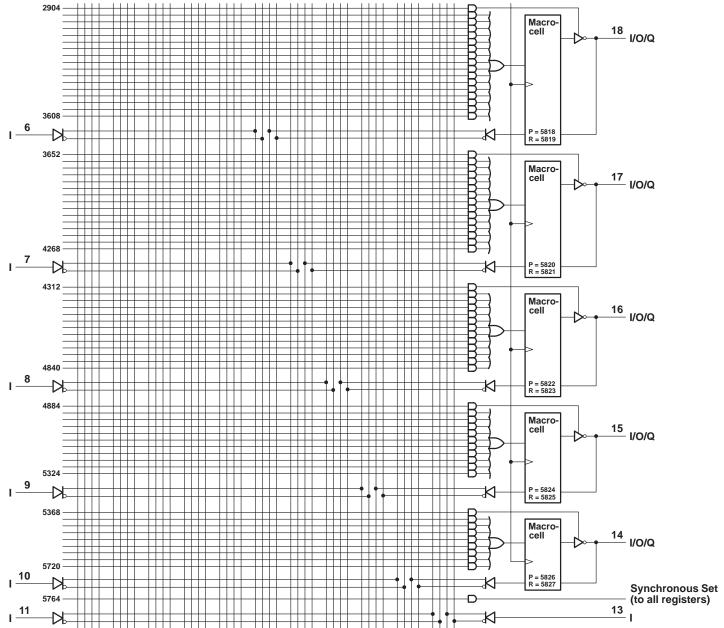
functional block diagram (positive logic)



 \sim denotes fused inputs

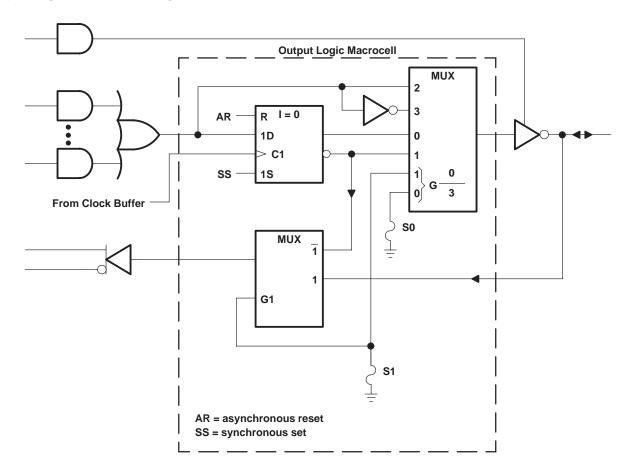






Fuse number = First Fuse number + Increment Inside each MACROCELL the "P" fuse is the polarity fuse and the "R" fuse is the register fuse. SRPS015 – D3972, FEBRUARY 1992

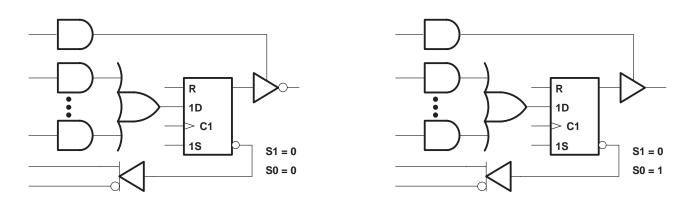
output logic macrocell diagram





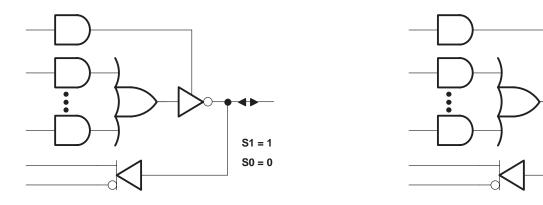
S1 = 1

S0 = 1



REGISTER FEEDBACK, REGISTERED, ACTIVE-LOW OUTPUT

REGISTER FEEDBACK, REGISTERED, ACTIVE-HIGH OUTPUT



I/O FEEDBACK, COMBINATIONAL, ACTIVE-LOW OUTPUT

I/O FEEDBACK, COMBINATIONAL, ACTIVE-HIGH OUTPUT

MACROCELL FEEDBACK AND OUTPUT FUNCTION TABLE

FUSE SELECT		FEEDBACK AND OUTPUT CONFIGURATION					
S1	S0	FEEDBACK AND OUTPUT CONFIGURATION					
0	0	Register feedback	Registered	Active low			
0	1	Register feedback	Registered	Active high			
1	0	I/O feedback	Combinational	Active low			
1	1	I/O feedback	Combinational	Active high			

 $^{0 = \}text{unblown fuse}, 1 = \text{blown fuse}$

Figure 1. Resultant Macrocell Feedback and Output Logic After Programming



S1 and S0 are select-function fuses as shown in the output logic macrocell diagram.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	7 V
Input voltage (see Note 1) –1.2 V to V _{CC} +0.	.5 V
Voltage range applied to disabled output (see Note 1)	.5 V
Operating free-air temperature range	5°C
Storage temperature range ——65°C to 150	0°C

NOTE 1: These ratings apply except for programming pins during a programming cycle or during a preload cycle.

recommended operating conditions

			MIN	NOM	MAX	UNIT
Vcc	Supply voltage			5	5.25	V
VIH	High-level input voltage (see Note 2)		2		5.5	V
V _{IL}	Low-level input voltage (see Note 2)				0.8	V
ІОН	High-level output current				-3.2	mA
loL	Low-level output current				16	mA
	Pulse duration	Clock high or low	5			ns
t _W		Asynchronous reset high or low	10			
		Input	7			ns
	Setup time before clock↑	Feedback	7			
t _{su}		Synchronous preset (active)	9			
		Synchronous preset (inactive)	8			
		Asynchronous reset (inactive)	8			
t _h	Hold time, input, set, or feedback after clock↑					ns
TA	Operating free-air temperature		0		75	°C

NOTE 2: These are absolute voltage levels with respect to the ground pin of the device and includes all overshoots due to system and/or tester noise. Testing these parameters should not be attempted without suitable equipment.



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electrical characteristics over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS			MIN	TYP [†]	MAX	UNIT	
VIK		$V_{CC} = 4.75 \text{ V},$	I _I = –18 mA				-1.2	V	
Vон		$V_{CC} = 4.75 \text{ V},$	$I_{OH} = -3.2 \text{ mA}$		2.4			V	
VOL		$V_{CC} = 4.75 \text{ V},$	$I_{OL} = 16 \text{ mA}$			0.35	0.5	V	
I _{OZH} ‡		V _{CC} = 5.25 V,	V _O = 2.7 V				0.1	mA	
l _{OZL} ‡		V _{CC} = 5.25 V,	V _O = 0.4 V				-0.1	mA	
lį		$V_{CC} = 5.25 \text{ V},$	V _I = 5.5 V				1	mA	
I _{IH} ‡		V _{CC} = 5.25 V,	V _I = 2.7 V				25	μΑ	
I _{IL}	CLK	Vcc = 5.25 V,	V _I = 0.4 V				-0.25	mA	
L'IL	All others	V(() = 0.20 v,	V = 0.1 V				-0.1		
IOS§		V _{CC} = 5.25 V,	V _O = 0.5 V		-30		-130	mA	
ICC		$V_{CC} = 5.25 \text{ V},$	$V_I = GND$,	Outputs open			210	mA	
Ci	I	f = 1 MHz,	V _I = 2 V			6		pF	
١	CLK	1 – 1 1411 12,	v - 2 v	v - 2 v		6	·	Ρ'	
Co		f = 1 MHz,	V _O = 2 V			8	·	pF	

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITION	MIN	MAX	UNIT
	Without	feedback		100		
$f_{max}\P$	With internal feedback	(counter configuration)		80		MHz
	With extern	al feedback		71		
t _{pd}	I, I/O	I/O	R1 = 300 Ω ,	1	10	ns
t _{pd}	I, I/O (reset)	Q	$R2 = 300 \Omega$,		15	ns
t _{pd}	CLK	Q	See Figure 6	1	7	ns
t _{pd} #	CLK	Feedback			5.5	ns
t _{en}	I, I/O	I/O, Q			11	ns
t _{dis}	I, I/O	I/O, Q			9	ns

$$f_{max} \text{ (without feedback)} = \frac{1}{t_{W}(\text{low}) + t_{W}(\text{high})}$$

$$f_{max} \text{ (with internal feedback)} = \frac{1}{t_{Su} + t_{pd}(\text{CLK to feedback})}$$

$$f_{max} \text{ (with external feedback)} = \frac{1}{t_{Su} + t_{pd}(\text{CLK to Q})}$$

[‡]I/O leakage is the worst case of IOZL and I_{IL} or IOZH and I_{IH}, respectively.

[§] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second. Vo is set at 0.5 V to avoid test problems caused by test equipment ground degradation.

[#]This parameter is calculated from the measured f_{max} with internal feedback in the counter configuration.

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preload procedure for registered outputs (see Notes 3 and 4)

The output registers can be preloaded to any desired state during device testing. This permits any state to be tested without having to step through the entire state-machine sequence. Each register is preloaded individually by following the steps given below:

- Step 1. With V_{CC} at 5 V and pin 1 at V_{II}, raise pin 13 to V_{IHH}.
- Step 2. Apply either V_{IL} or V_{IH} to the output corresponding to the register to be preloaded.
- Step 3. Pulse pin 1, clocking in preload data.
- Step 4. Remove output voltage, then lower pin 13 to V_{IL}. Preload can be verified by observing the voltage level at the output pin.

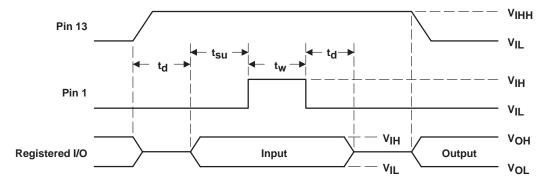


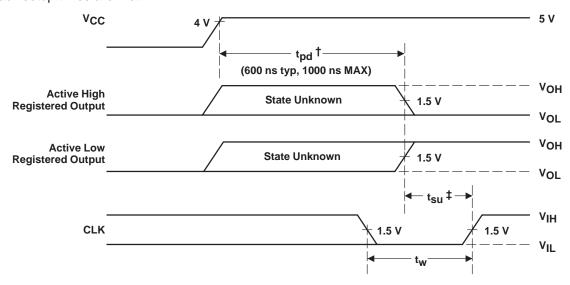
Figure 2. Preload Waveforms

NOTES: 3. Pin numbers shown are for the NT package only. If chip-carrier socket adapter is not used, pin numbers must be changed accordingly.

4. $t_d = t_{SU} = t_W = 100 \text{ ns to } 1000 \text{ ns. } V_{IHH} = 10.25 \text{ V to } 10.75 \text{ V}.$

power-up reset

Following power up, all registers are reset to zero. The output level depends on the polarity selected during programming. This feature provides extra flexibility to the system designer and is especially valuable in simplifying state-machine initialization. To ensure a valid power-up reset, it is important that the rise of V_{CC} be monotonic. Following power-up reset, a low-to-high clock transition must not occur until all applicable input and feedback setup times are met.



[†] This is the power-up reset time and applies to registered outputs only. The values shown are from characterization data.

Figure 3. Power-Up Reset Waveforms

programming information

Texas Instruments programmable logic devices can be programmed using widely available software and inexpensive device programmers.

Complete programming specifications, algorithms, and the latest information on hardware, software, and firmware are available upon request. Information on programmers capable of programming Texas Instruments programmable logic is also available, upon request, from the nearest TI field sales office, local authorized TI distributor, or by calling Texas Instruments at (214) 997-5666.

[‡] This is the setup time for input or feedback.

THERMAL INFORMATION

thermal management of the TIBPAL22V10-10C

Thermal management of the TIBPAL22V10-10CNT and TIBPAL22V10-10CFN is necessary when operating at certain conditions of frequency, output loading, and outputs switching simultaneously. The device and system application will determine the appropriate level of management.

Determining the level of thermal management is based on factors such as power dissipation (P_D) , ambient temperature (T_A) , and transverse airflow (FPM). Figures 4 (a) and 4 (b) show the relationship between ambient temperature and transverse airflow at given power dissipation levels. The required transverse airflow can be determined at a particular ambient temperature and device power dissipation level in order to ensure the device specifications.

Figure 5 illustrates how power dissipation varies as a function of frequency and the number of outputs switching simultaneously. It should be noted that all outputs are fully loaded ($C_L = 50 \, \text{pF}$). Since the condition of eight fully loaded outputs represents the worst-case condition, each application must be evaluated accordingly.

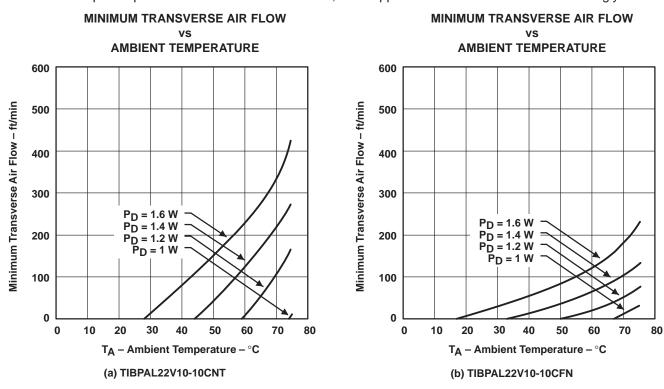


Figure 4

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THERMAL INFORMATION

POWER DISSIPATION vs FREQUENCY

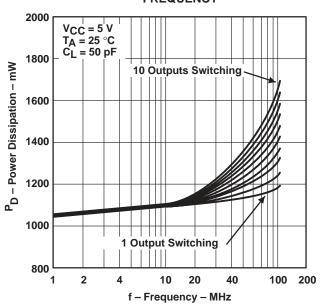
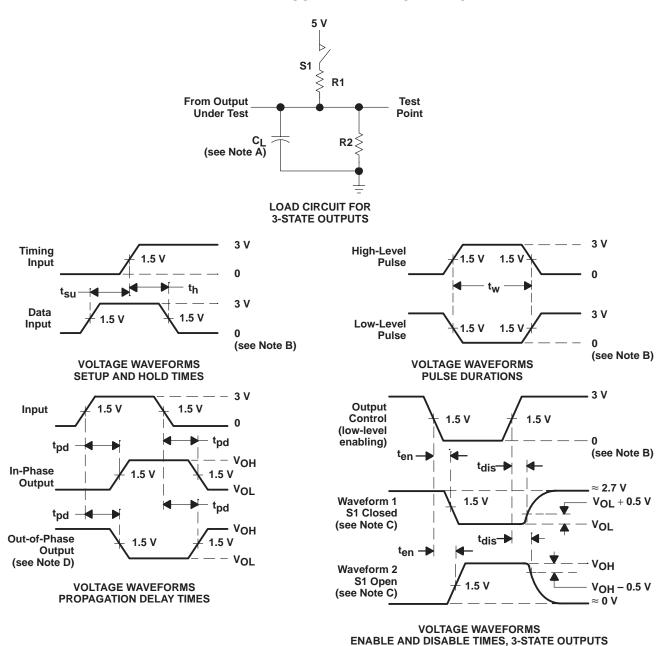


Figure 5

PARAMETER MEASUREMENT INFORMATION



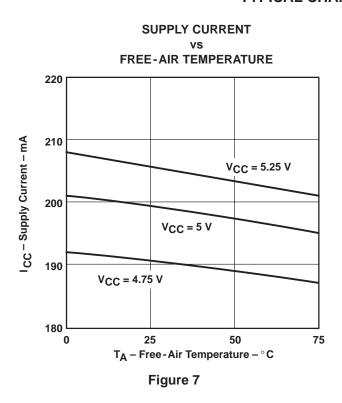
NOTES: A. CL includes probe and jig capacitance and is 50 pF for tpd and ten, 5 pF for tdis.

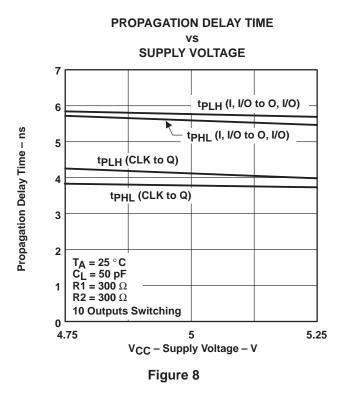
- B. All input pulses have the following characteristics: $PRR \le 1$ MHz, $t_f = t_f = 2$ ns, duty cycle = 50%.
- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- D. When measuring propagation delay times of 3-state outputs, switch S1 is closed.
- E. Equivalent loads may be used for testing.

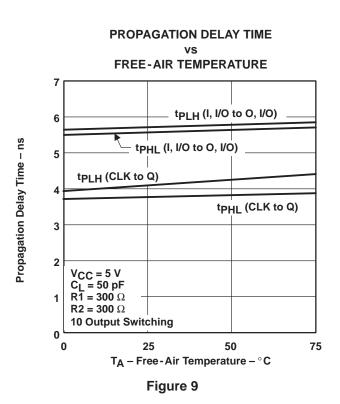
Figure 6. Load Circuit and Voltage Waveforms

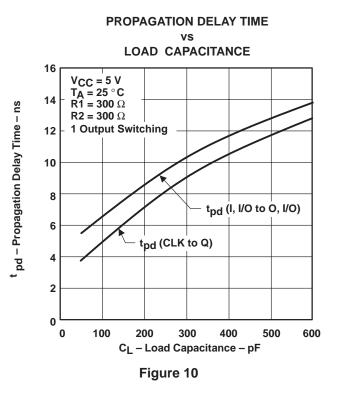


TYPICAL CHARACTERISTICS









TYPICAL CHARACTERISTICS

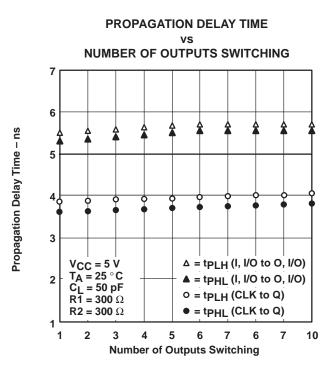
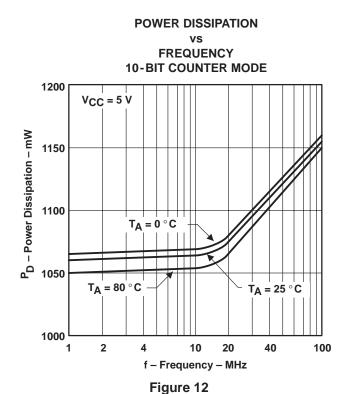


Figure 11



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